128M~2GB miniSD Memory Card

Description

miniSD Card is a compact, slim and high capacity storage media with copyright protection. Designed in advanced SD specification Ver.1.1, TS2GSDM80 now reaches a new performance milestone. Based on 0.18um process controller and high quality SLC (Single-Level-Cell) NAND Flash chip, TS128M~ 2GSDM80 can provide high performance ,low power consumption yet excellent reliability.

Placement



Front

9 1 2 3 10 11 4 5 6 7 8

Back

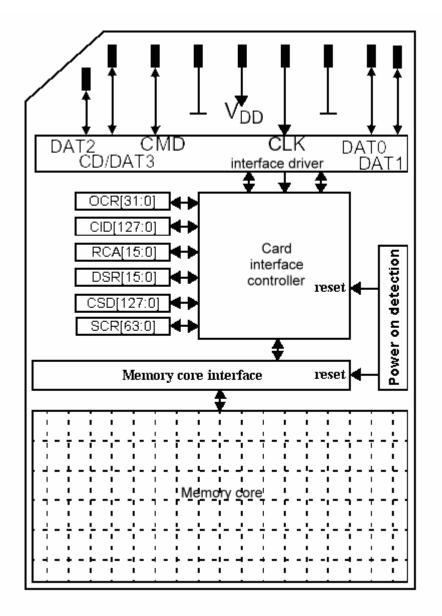
Features

- Storage Capacity: 2GB(2GX8bit,2KB/page)
- Operating Voltage: 2.7 ~ 3.6V
- Operating Temperature: -25 ~ 85°C
- Maximum Data Transfer Rate: Read:12MB/sec.Write:11MB/sec
- Insertion/removal durability: 10,000 cycles
- Fully compatible with SD card spec. v1.1
- Forward compatibility to MultiMediaCard Version 2.11
- Supports Copy Protection for Recorded Media(CPRM) for music and other commercial media
- Form Factor: 21.5mm x 20mm x 1.4mm

Pin Definition

Pin No.	Name	Туре	Description
1	CD/DAT3	I/O/PP ³	Card Detect/Data Line [Bit3]
2	CMD	PP	Command/Response
3	V _{SS1}	S	Supply voltage ground
4	V _{DD}	S	Supply voltage
5	CLK	-	Clock
6	V _{SS2}	S	Supply voltage ground
7	DAT0	I/O/PP	Data Line [Bit0]
8	DAT1	I/O/PP	Data Line [Bit1]
9	DAT2	I/O/PP	Data Line [Bit2]
10	NC ⁴	I/O/PP	For Future Use
11	NC ⁴	I/O/PP	For Future Use

Architecture



Bus Operating Conditions

General

Parameter	Symbol	Min.	Max.	Unit	Remark
Peak voltage on all lines		-0.3	VDD+0.3	V	
All Inputs					
Input Leakage Current		-10	10	μA	
All Outputs					
Output Leakage Current		-10	10	μA	

Power Supply Voltage

Parameter	Symbol	Min.	Max.	Unit	Remark
Supply voltage	V_{DD}	2.0	3.6	V	CMD0, 15,55,ACMD41
					commands
Supply voltage specified in OCR register		2.7	3.6	V	Except CMD0, 15,55,
					ACMD41 commands
Supply voltage differentials (V_{SS1} , V_{SS2})		-0.3	0.3	V	
Power up time			250	ms	From 0v to V _{DD} Min.

Note. The current consumption of any card during the power-up procedure must not exceed 10 mA.

Bus Signal Line Load

The total capacitance C_L the CLK line of the SD Memory Card bus is the sum of the bus master capacitance C_{HOST} , the bus capacitance C_{BUS} itself and the capacitance C_{CARD} of each card connected to this line: $C_L = C_{HOST} + C_{BUS} + N^*C_{CARD}$

Where N is the number of connected cards. Requiring the sum of the host and bus capacitances not to exceed 30 pF for up to 10 cards, and 40 pF for up to 30 cards, the following values must not be exceeded:

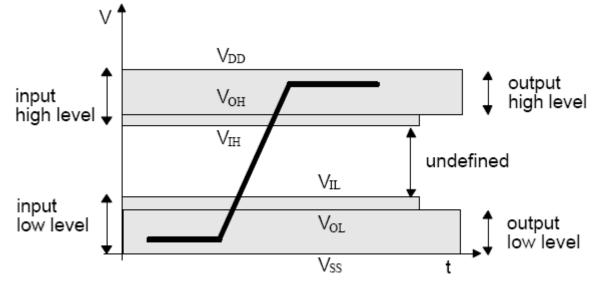
Parameter	Symbol	Min.	Max.	Unit	Remark
Bus signal line capacitance	CL		100	pF	$f_{PP} \le 20 \text{ MHz}, 7 \text{ cards}$
Single card capacitance	C _{CARD}		10	pF	
Maximum signal line inductance			16	nH	f _{PP} ≤ 20 MHz
Pull-up resistance inside card (pin1)	R _{DAT3}	10	90	kΩ	May be used for card
					detection

Note that the total capacitance of CMD and DAT lines will be consist of C_{HOST} , C_{BUS} and one C_{CARD} only since they are connected separately to the SD Memory Card host.

Parameter	Symbol	Min.	Max.	Unit	Remark
Pull-up resistance	R_{CMD}, R_{DAT}	10	100	kΩ	To prevent bus floating
Bus signal line capacitance	CL		250	рF	$f_{PP} \le 5 \text{ MHz}$, 21 cards

Bus Signal Levels

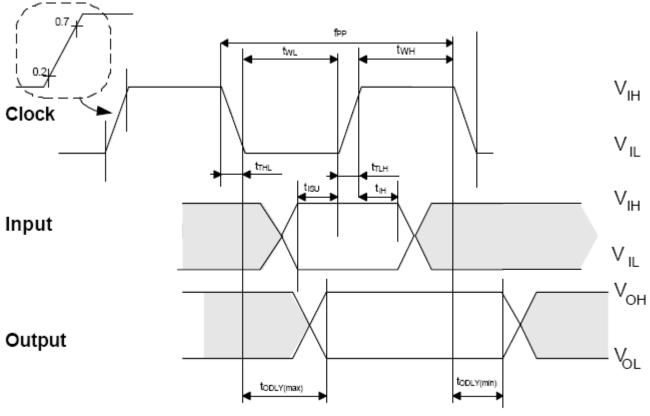
As the bus can be supplied with a variable supply voltage, all signal levels are related to the supply voltage.



To meet the requirements of the JEDEC specification JESD8-1A, the card input and output voltages shall be within the following specified ranges for any V_{DD} of the allowed voltage range:

Parameter	Symbol	Min.	Max.	Unit	Remark
Output HIGH voltage	V _{OH}	0.75* V _{DD}		V	I _{OH} = -100 μA @V _{DD} min
Output LOW voltage	V _{OL}		0.125* V _{DD}	V	I _{OL} = -100 μA @V _{DD} min
Input HIGH voltage	V _{IH}	$0.625*V_{DD}$	V _{DD} + 0.3	V	
Input LOW voltage	V _{IL}	$V_{SS} - 0.3$	0.25* V _{DD}	V	

• Bus Timing (Default)



Shaded areas are not valid

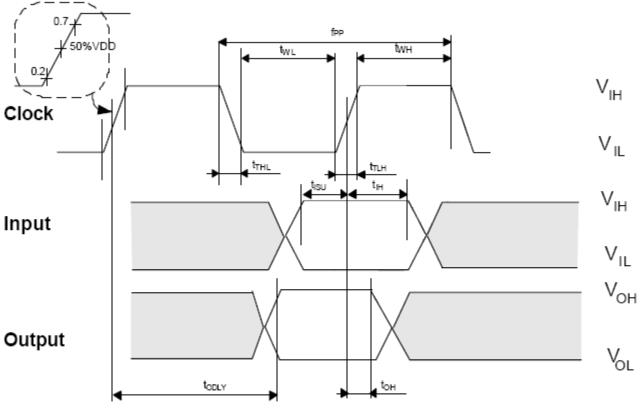
Figure 47: Timing diagram data input/output referenced to clock (Default)

Parameter	Symbol	Min	Max.	Unit	Remark	
Clock CLK (All values are referred to min (V_{IH}) a	Clock CLK (All values are referred to min (V_{IH}) and max (V_{IL})					
Clock frequency Data Transfer Mode	f _{PP}	0	25	MHz	$C_L \le 100 \text{ pF}$, (7 cards)	
Clock frequency Identification Mode	f _{OD}	0	400	KHz	$C_L \le 250 \text{ pF}$, (21 cards)	
(The low freq. is required for MultiMediaCard						
compatibility.)						
Clock low time	t _{WL}	10		ns	$C_L \le 100 \text{ pF}$, (7 cards)	
		50		ns	$C_L \le 250 \text{ pF}$, (21 cards)	
Clock high time	t _{WH}	10		ns	$C_L \leq 100 \text{ pF}$, (7 cards)	
		50		ns	$C_L \le 250 \text{ pF}$, (21 cards)	
Clock rise time	t_{TLH}		10	ns	$C_L \le 100 \text{ pF}$, (7 cards)	

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			50	ns	$C_{L} \leq 250 \text{ pF}$, (21 cards)
Clock fall time	t _{THL}		10	ns	$C_{L} \leq 100 \text{ pF}, (7 \text{ cards})$
			50	ns	$C_L \le 250 \text{ pF}$, (21 cards)
Inputs CMD, DAT (referenced to CLK)					
Input set-up time	t _{ISU}	5		ns	$C_{L} \leq 25 \text{ pF}, (1 \text{ cards})$
Input hold time	t _{IH}	5		ns	$C_L \le 25 \text{ pF}, (1 \text{ cards})$
Outputs CMD, DAT (referenced to CLK)					
Output Delay time during Data Transfer Mode	t _{ODLY}	0	14	ns	$C_{L} \leq 25 \text{ pF}, (1 \text{ cards})$
Output Delay time during Identification Mode	t _{ODLY}	0	50	ns	$C_{L} \leq 25 \text{ pF}, (1 \text{ cards})$

• Bus Timing (High Speed Mode)



Shaded areas are not valid

Figure 48: Timing diagram data input/output referenced to clock (High-Speed)

Parameter	Symbol	Min	Max.	Unit	Remark
Clock CLK (All values are referred to min (VIH) a	and max (V	′ı∟)			
Clock frequency Data Transfer Mode	f _{PP}	0	50	MHz	
Clock low time	t _{WL}	7		ns	
Clock high time	t _{wH}	7		ns	
Clock rise time	t _{TLH}		3	ns	
Clock fall time	t _{THL}		3	ns	
Inputs CMD, DAT (referenced to CLK)					
Input set-up time	t _{ISU}	6		ns	
Input hold time	t _{IH}	2		ns	
Dutputs CMD, DAT (referenced to CLK)					

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Output Delay time during Data Transfer Mode	t _{ODLY}		14	ns	
Output Hold time	t _{он}	2.5		ns	
Total System capacitance for each line	CL		40	pF	

Reliability and Durability

Temperature	Operation: -25°C / 85°C (Target spec)
	Storage: -40°C (168h) / 85°C (500h)
	Junction temperature: max. 95°C
Moisture and corrosion	Operation: 25°C / 95% rel. humidity
	Storage: 40°C / 93% rel. hum./500h
	Salt Water Spray: 3% NaCl/35C; 24h acc. MIL STD Method 1009
Durability	10.000 mating cycles;
Bending	10N
Torque	0.15N.m or +/-2.5 deg
Drop test	1.5m free fall
UV light exposure	UV: 254nm, 15Ws/cm ² according to ISO 7816-1
Visual inspection	No warp page; no mold skin; complete form; no cavities surface smoothness <=
Shape and form	-0.1 mm/cm ² within contour; no cracks; no pollution (fat, oil dust, etc.)

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